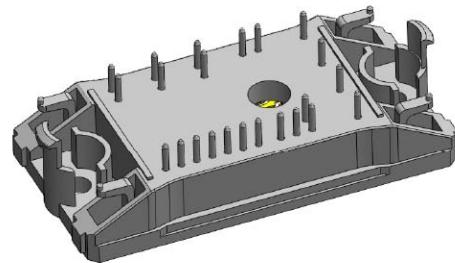


STARPOWER

SEMICONDUCTOR

IGBT

GD20PJK60F1S

Molding Type Module**600V/20A PIM in one-package**

General Description

STARPOWER IGBT Power Module provides ultra low conduction and switching loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

Features

- Low $V_{CE(sat)}$ NPT IGBT technology
- 10 μ s short circuit capability
- Square RBSOA
- $V_{CE(sat)}$ with positive temperature coefficient
- Fast & soft reverse recovery anti-parallel FWD

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

IGBT-inverter $T_c=25^\circ\text{C}$ unless otherwise noted

Maximum Rated Values

Symbol	Description	GD20PJK60F1S	Units
V_{CES}	Collector-Emitter Voltage @ $T_i=25^\circ\text{C}$	600	V
V_{GES}	Gate-Emitter Voltage @ $T_i=25^\circ\text{C}$	± 20	V
I_C	Collector Current @ $T_c=25^\circ\text{C}$ @ $T_c=80^\circ\text{C}$	40 20	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	40	A
P_{tot}	Total Power Dissipation @ $T_j=150^\circ\text{C}$	106	W

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^\circ\text{C}$	600			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			1.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=250\mu\text{A}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	3.5	4.5	5.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=20\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.80	2.25	V
		$I_C=20\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		2.10		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300V, I_C=20A, R_G=16\Omega, V_{GE}=\pm 15V, T_j=25^\circ C$		70		ns
t_r	Rise Time			21		ns
$t_{d(off)}$	Turn-Off Delay Time			113		ns
t_f	Fall Time			119		ns
E_{on}	Turn-On Switching Loss			0.34		mJ
E_{off}	Turn-Off Switching Loss			0.26		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300V, I_C=20A, R_G=16\Omega, V_{GE}=\pm 15V, T_j=125^\circ C$		84		ns
t_r	Rise Time			31		ns
$t_{d(off)}$	Turn-Off Delay Time			113		ns
t_f	Fall Time			141		ns
E_{on}	Turn-On Switching Loss			0.47		mJ
E_{off}	Turn-Off Switching Loss			0.39		mJ
C_{ies}	Input Capacitance	$V_{CE}=30V, f=1Mhz, V_{GE}=0V$		1240		pF
C_{oes}	Output Capacitance			124		pF
C_{res}	Reverse Transfer Capacitance			44		pF
Q_G	Gate Charge	$V_{CC}=400V, I_C=20A, V_{GE}=15V$		71		nC
R_{Gint}	Internal Gate Resister			/		Ω
I_{SC}	SC Data	$t_p \leq 10\mu s, V_{GE}=15V, T_j=125^\circ C, V_{CC}=400V, V_{CEM} \leq 600V$		180		A

Diode-inverter $T_C=25^\circ C$ unless otherwise noted

Maximum Rated Values

Symbol	Description	GD20PJK60F1S	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^\circ C$	600	V
I_F	DC Forward Current	20	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1ms$	40	A

Characteristics Values

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=20A, V_{GE}=0V$	$T_j=25^\circ C$	1.30	1.75	V
			$T_j=125^\circ C$	1.25		
Q_r	Recovered Charge	$I_F=20A, V_R=300V, R_G=16\Omega, V_{GE}=-15V$	$T_j=25^\circ C$	1.1		μC
			$T_j=125^\circ C$	1.7		
I_{RM}	Peak Reverse Recovery Current	$V_R=300V, R_G=16\Omega, V_{GE}=-15V$	$T_j=25^\circ C$	32		A
			$T_j=125^\circ C$	37		
E_{rec}	Reverse Recovery Energy	$V_R=300V, R_G=16\Omega, V_{GE}=-15V$	$T_j=25^\circ C$	0.27		mJ
			$T_j=125^\circ C$	0.43		

Diode-rectifier $T_C=25^\circ\text{C}$ unless otherwise noted

Maximum Rated Values

Symbol	Description	GD30PIK60C5S	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^\circ\text{C}$	1600	V
$I_{F(AV)}$	Average On-state Current @ $T_C=100^\circ\text{C}$	20	A
I_{RMSM}	Maximum RMS Current At Rectifier Output @ $T_C=80^\circ\text{C}$	40	A
I_{FSM}	Surge Forward Current $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^\circ\text{C}$	270	A
I^2t	I^2t -value, $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^\circ\text{C}$	360	A^2s

Characteristics Values

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=20\text{A}$	$T_j=150^\circ\text{C}$		1.11		V
I_R	Reverse Current	$T_j=150^\circ\text{C}, V_R=1600\text{V}$				1.0	mA

IGBT-brake-chopper $T_C=25^\circ\text{C}$ unless otherwise noted

Maximum Rated Values

Symbol	Description	GD20PJK60F1S	Units
V_{CES}	Collector-Emitter Voltage @ $T_j=25^\circ\text{C}$	600	V
V_{GES}	Gate-Emitter Voltage @ $T_j=25^\circ\text{C}$	± 20	V
I_C	Collector Current @ $T_C=25^\circ\text{C}$ @ $T_C=80^\circ\text{C}$	26 15	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	30	A
P_{tot}	Total Power Dissipation @ $T_j=175^\circ\text{C}$	82	W

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^\circ\text{C}$	600			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			1.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=250\mu\text{A}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	3.5	4.5	5.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=15\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.80	2.25	V
		$I_C=15\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		2.05		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400V, I_C=15A, R_G=16\Omega, V_{GE}=\pm 15V, T_j=25^\circ C$		60		ns
t_r	Rise Time			20		ns
$t_{d(off)}$	Turn-Off Delay Time			88		ns
t_f	Fall Time			135		ns
E_{on}	Turn-On Switching Loss			0.24		mJ
E_{off}	Turn-Off Switching Loss			0.18		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400V, I_C=15A, R_G=16\Omega, V_{GE}=\pm 15V, T_j=125^\circ C$		60		ns
t_r	Rise Time			22		ns
$t_{d(off)}$	Turn-Off Delay Time			97		ns
t_f	Fall Time			145		ns
E_{on}	Turn-On Switching Loss			0.39		mJ
E_{off}	Turn-Off Switching Loss			0.26		mJ
C_{ies}	Input Capacitance	$V_{CE}=30V, f=1Mhz, V_{GE}=0V$		850		pF
C_{oes}	Output Capacitance			75		pF
C_{res}	Reverse Transfer Capacitance			35		pF
Q_G	Gate Charge	$V_{CC}=400V, I_C=15A, V_{GE}=15V$		56		nC
R_{Gint}	Internal Gate Resister			/		Ω
I_{SC}	SC Data	$t_p \leq 10\mu s, V_{GE}=15V, T_j=125^\circ C, V_{CC}=400V, V_{CEM} \leq 600V$		135		A

Diode-brake-chopper $T_c=25^\circ C$ unless otherwise noted

Maximum Rated Values

Symbol	Description	GD20PJK60F1S	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^\circ C$	600	V
I_F	DC Forward Current	15	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1ms$	30	A

Characteristics Values

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=15A, V_{GE}=0V$	$T_j=25^\circ C$		1.20	1.60	V
			$T_j=125^\circ C$		1.15		
Q_r	Recovered Charge	$I_F=15A, V_R=300V, R_G=16\Omega, V_{GE}=-15V$	$T_j=25^\circ C$		0.9		μC
			$T_j=125^\circ C$		1.4		
I_{RM}	Peak Reverse Recovery Current	$V_R=300V, R_G=16\Omega, V_{GE}=-15V$	$T_j=25^\circ C$		27		A
			$T_j=125^\circ C$		31		
E_{rec}	Reverse Recovery Energy	$V_R=300V, R_G=16\Omega, V_{GE}=-15V$	$T_j=25^\circ C$		0.23		mJ
			$T_j=125^\circ C$		0.36		

NTC $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
R_{25}	Rated Resistance			22.0		$\text{k}\Omega$
$\Delta R/R$	Deviation of R_{100}	$T_C=100^\circ\text{C}, R_{100}=1486.1\Omega$	-5		5	%
P_{25}	Power Dissipation				200	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2 - 1/(298.15\text{K}))]$		4000		K

IGBT Module

Symbol	Parameter	Min.	Typ.	Max.	Units
V_{ISO}	Isolation Voltage RMS,f=50Hz,t=1min	4000			V
$R_{\theta JC}$	Junction-to-Case (per IGBT-inverter)			1.182	K/W
	Junction-to-Case (per Diode-inverter)			2.578	
	Junction-to-Case (per Diode-rectifier)			1.611	
	Junction-to-Case (per IGBT-brake-chopper)			1.533	
	Junction-to-Case (per Diode-brake-chopper)			2.812	
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)		0.036		K/W
T_{jmax}	Maximum Junction Temperature			150	$^\circ\text{C}$
T_{jop}	Operating Junction Temperature	-40		125	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-40		125	$^\circ\text{C}$

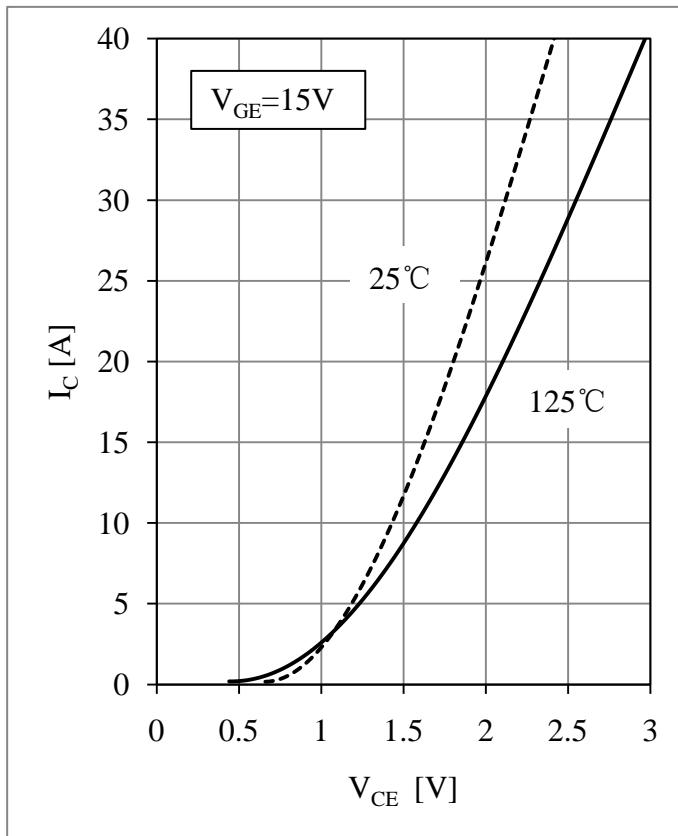


Fig 1. IGBT-inverter Output Characteristic

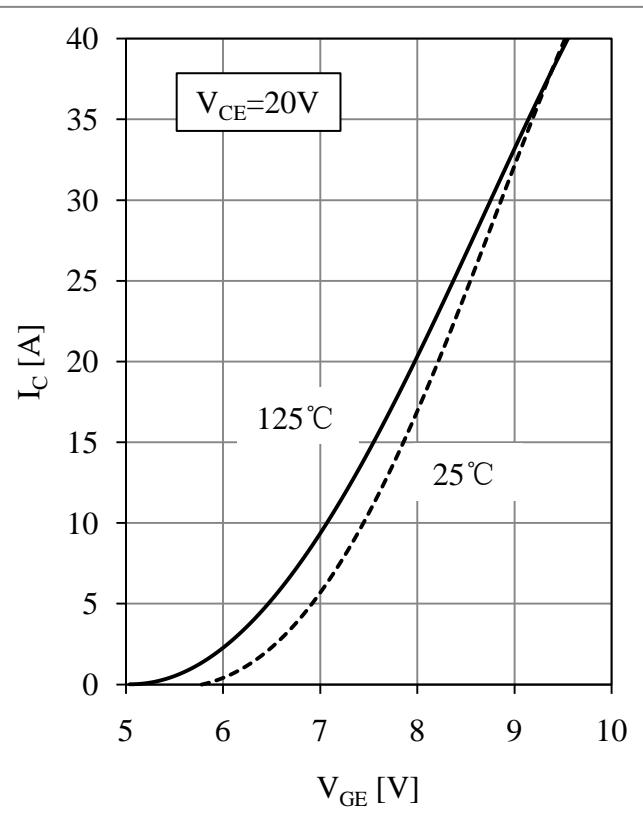
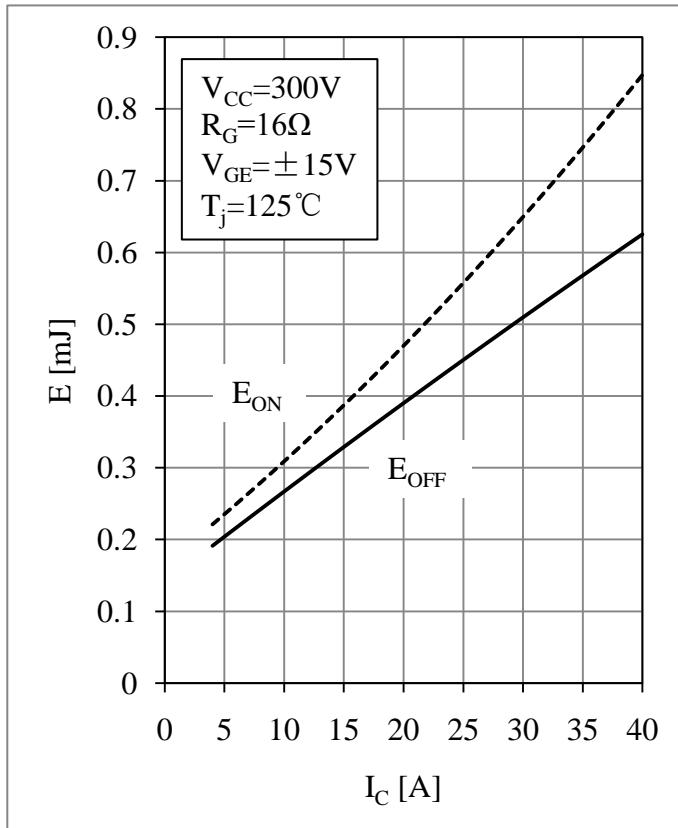
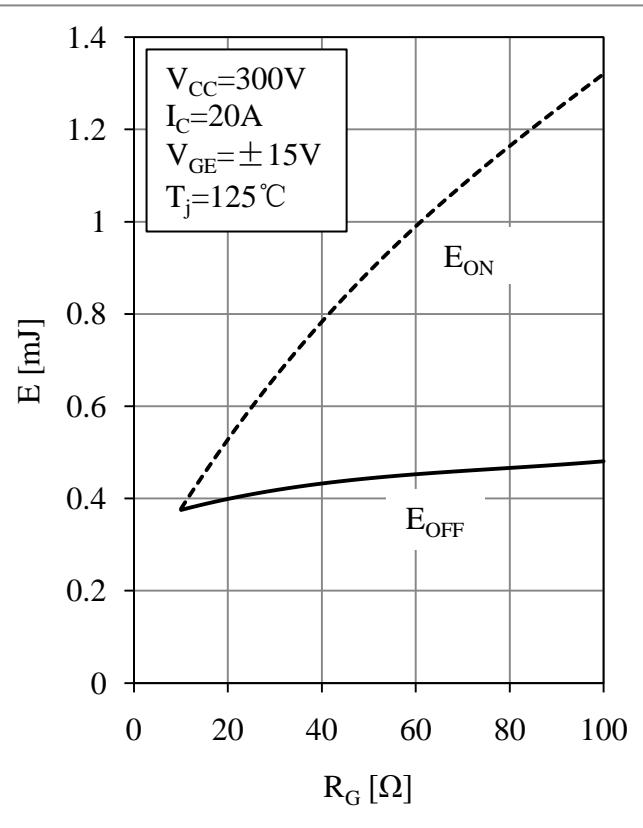


Fig 2. IGBT-inverter Transfer Characteristic

Fig 3. IGBT-inverter Switching Loss vs. I_C Fig 4. IGBT-inverter Switching Loss vs. R_G

GD20PJK60F1S

IGBT Module

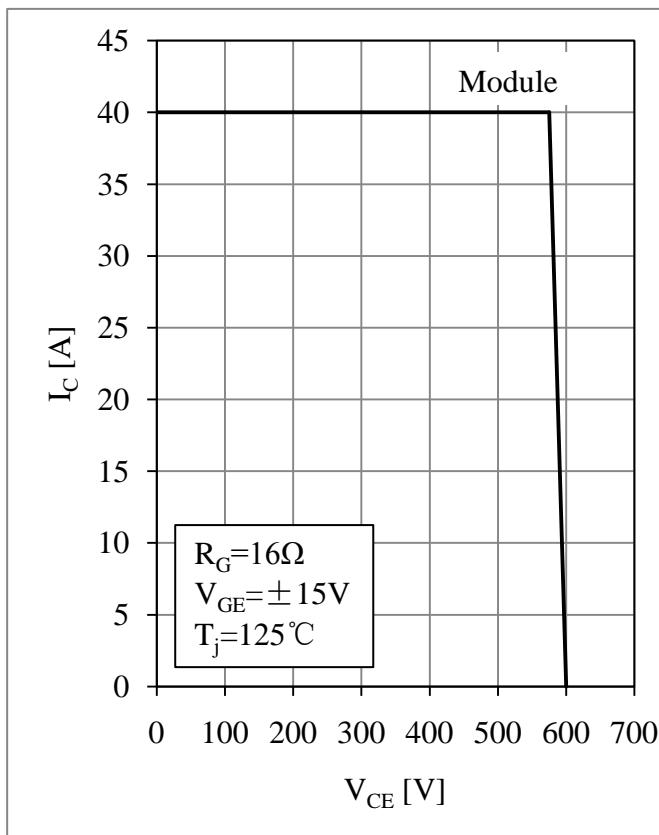


Fig 5. IGBT-inverter RBSOA

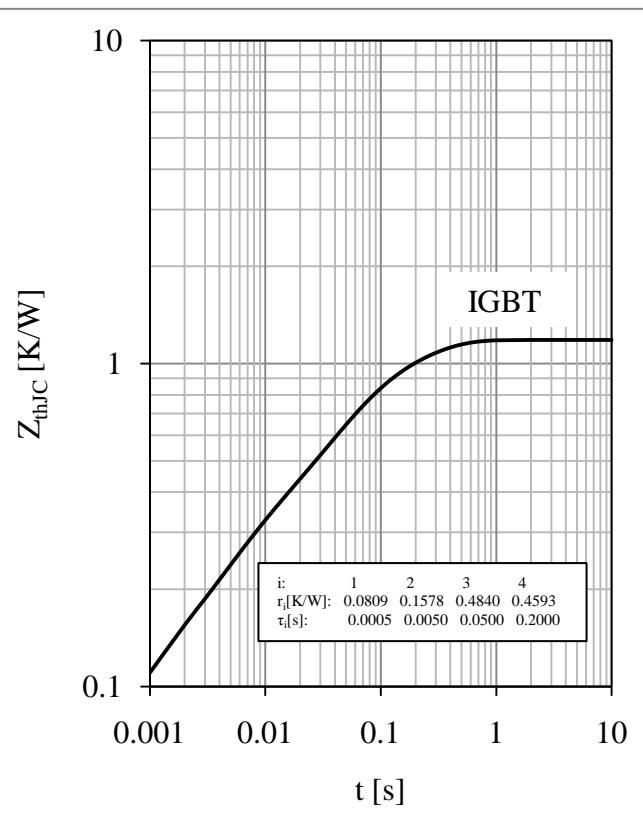


Fig 6. IGBT-inverter Transient Thermal Impedance

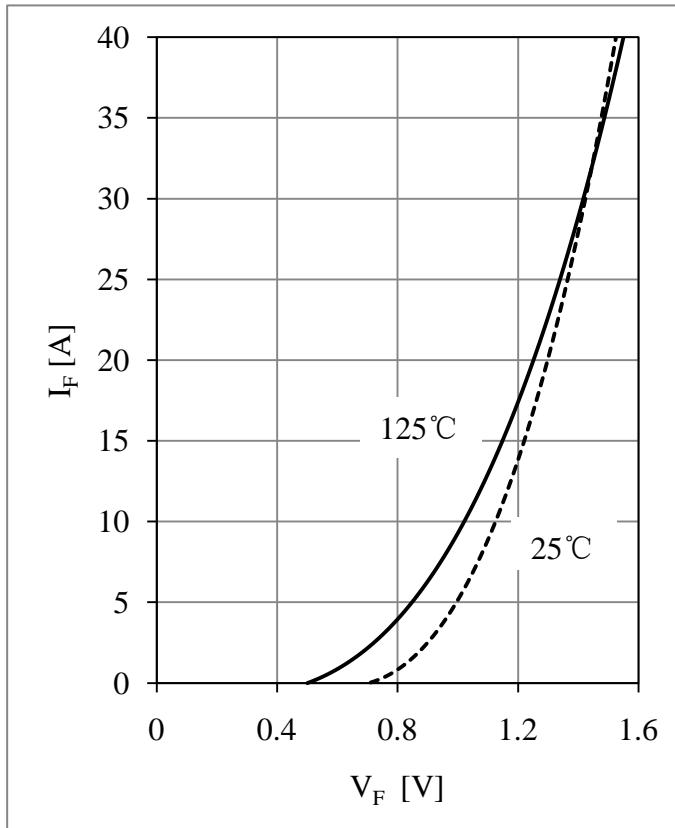


Fig 7. Diode-inverter Forward Characteristic

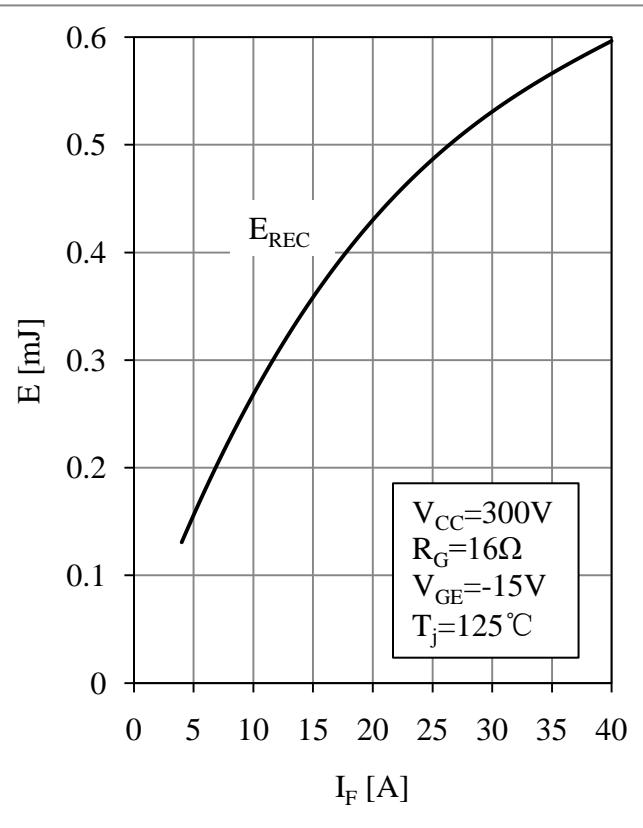


Fig 8. Diode-inverter Switching Loss vs. I_F

GD20PJK60F1S

IGBT Module

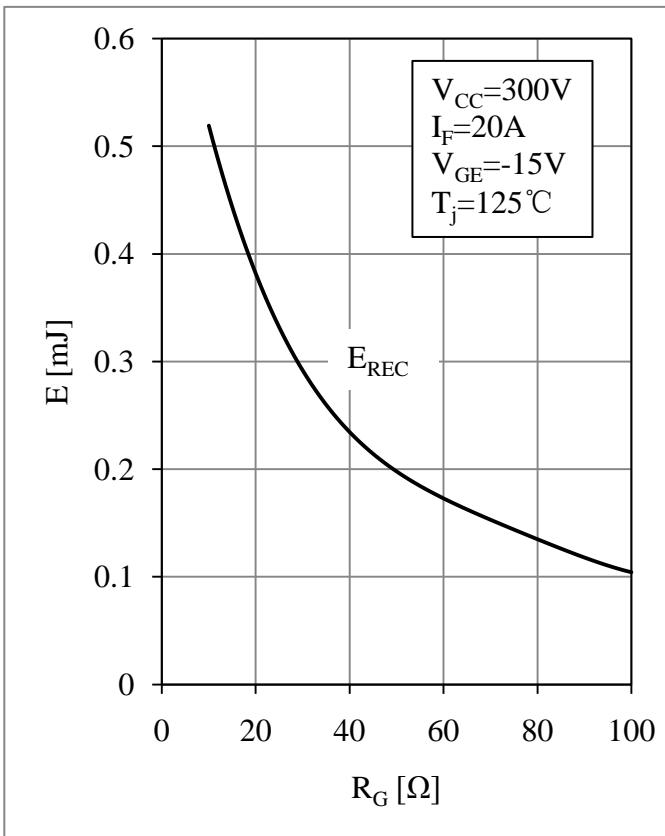


Fig 9. Diode-inverter Switching Loss vs. R_G

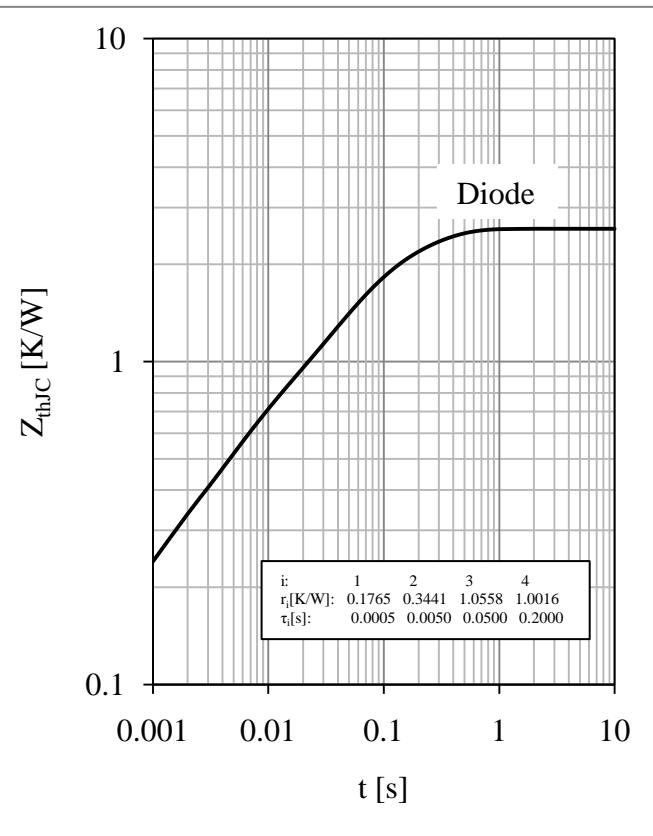


Fig 10. Diode-inverter Transient Thermal Impedance

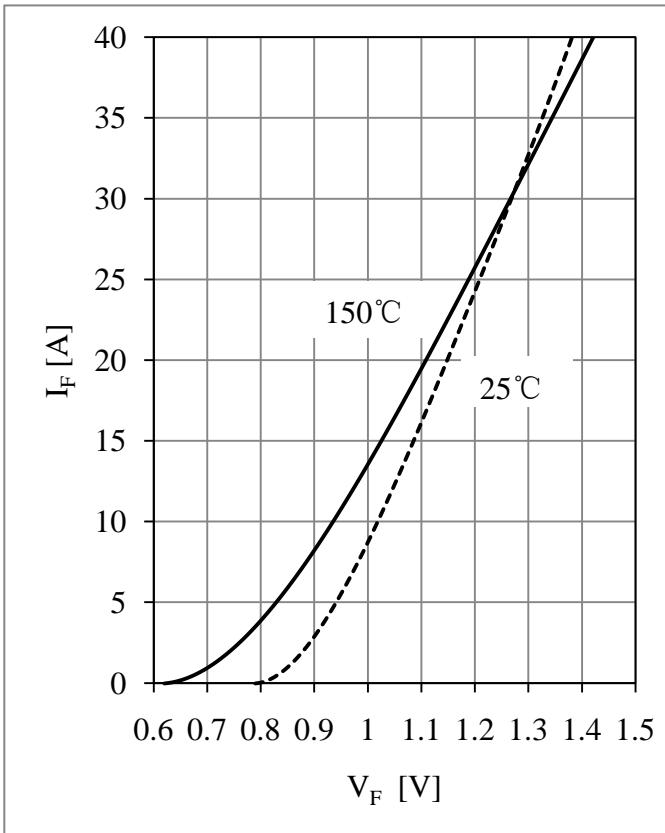


Fig 11. Diode-rectifier Forward Characteristic

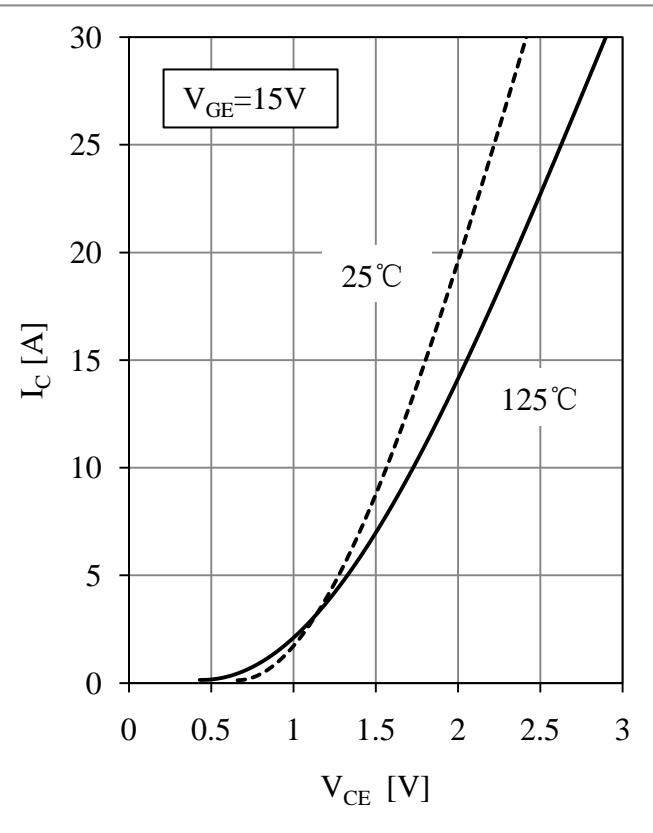


Fig 12. IGBT-brake-chopper Output Characteristic

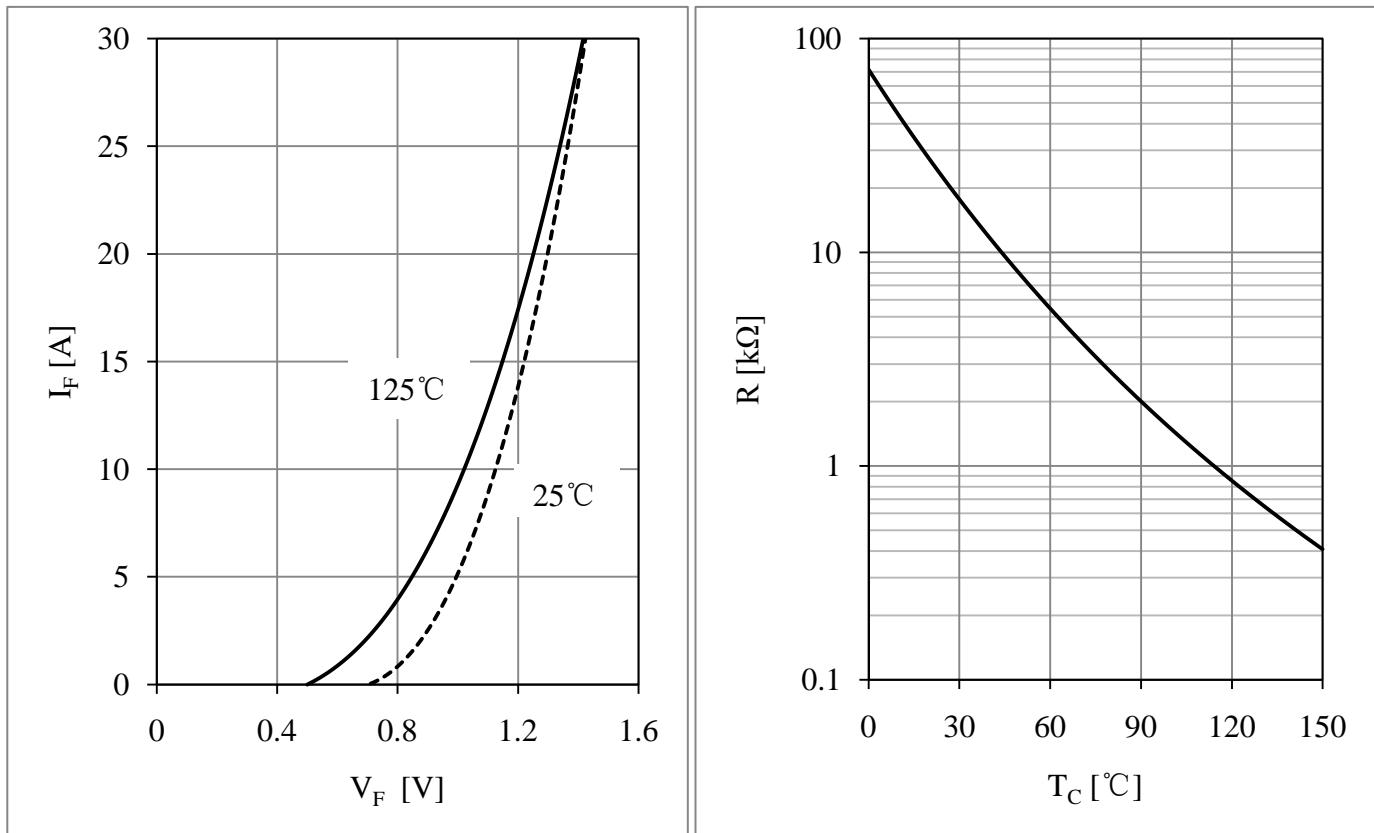
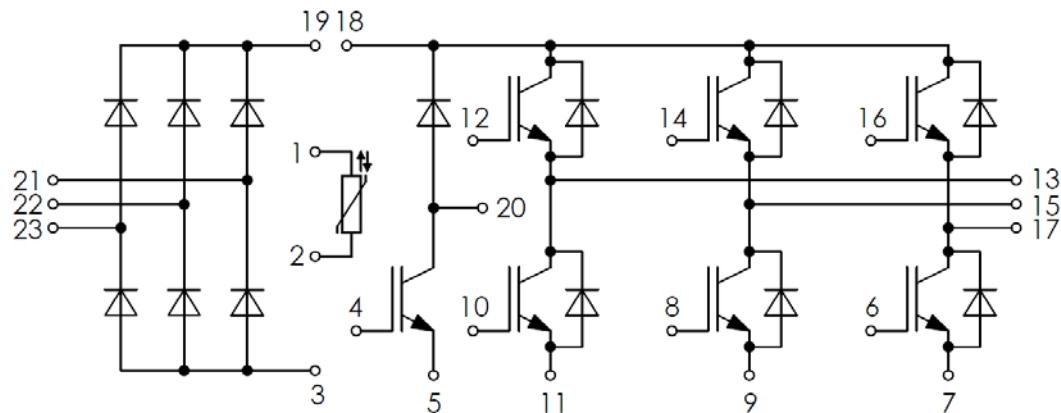


Fig 13. Diode-brake-chopper Forward Characteristic

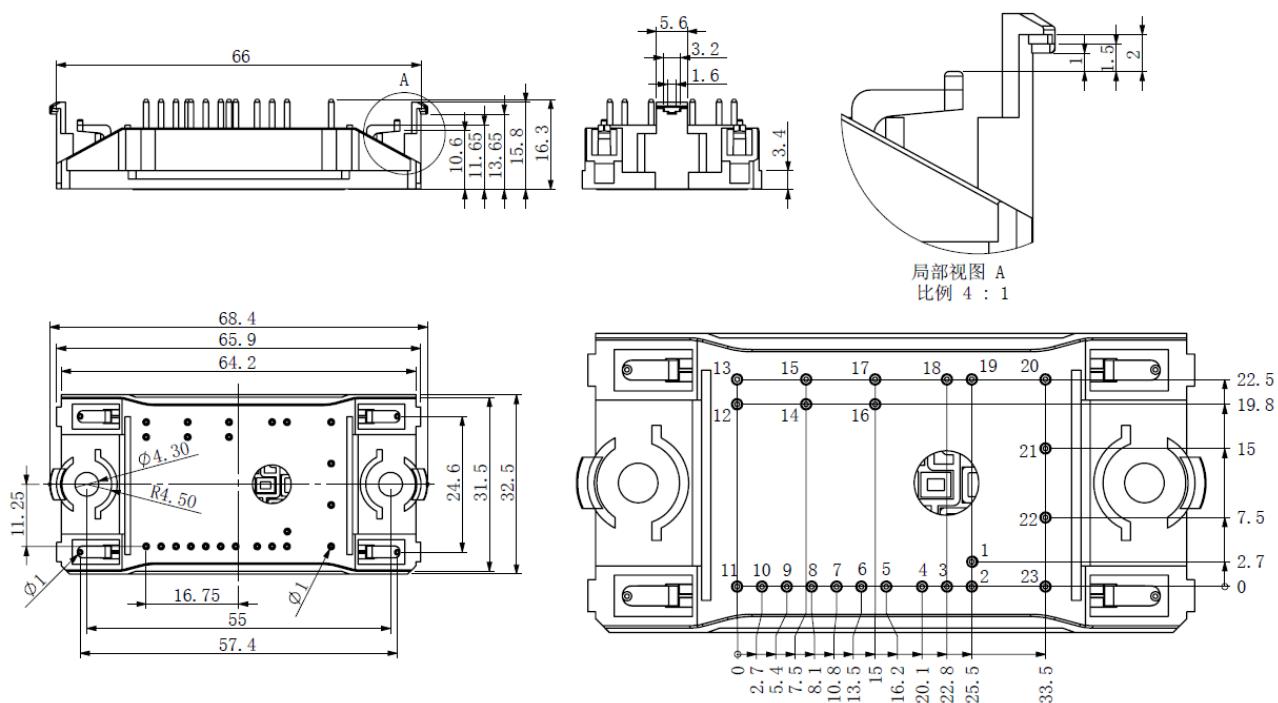
Fig 14. NTC Temperature Characteristic

Equivalent Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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